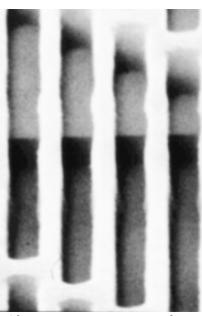


without AZ® Aquatar® at +0.6 µm focus



with AZ® Aquatar® at +0.6 µm focus



AZ® Aquatar®

Top Anti-Reflective Coating

AZ® Aquatar® top anti-reflective coating is an aqueous material for use with positive photoresists in the semiconductor industry.

The effect of the anti-reflective coating is to dramatically reduce the amplitude of the resist swing curve. When optimized this change in swing curve amplitude can be up to a factor of three times reduction.

Optimum film thickness can be calculated using the following function:

Film thickness = $\frac{\lambda}{4n}$

 λ = wavelength of exposure light n = refractive index of AZ® Aquatar®

After exposure AZ® Aquatar® top antireflective coating is removed using either a water rinse or the aqueous positive resist developer itself. As soon as the anti-reflective coating is removed the resist will develop as normal. An optimized process is confirmed when the original resist swing curve is seen to be exactly 180° out of phase with the modified swing curve derived from the use of AZ® Aquatar® top anti-reflective coating. When this is not the case there will still be a significant swing curve reduction but not to the same extent as a fully optimized process. When used with AZ® i-line photoresists, image bias, usually seen as a difference in dimension between dense and isolated lines is dramatically reduced to values close to 0%

A top anti-reflective coating will not reduce reflective notching caused by exposing light being reflected from the substrate. For this process situation a bottom anti-reflective coating, AZ® BARLi®, is recommended.

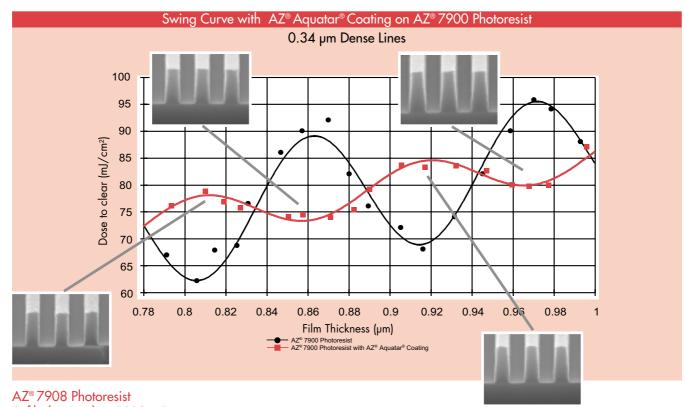


Focus Latitude

of 0.5 µm Lines and Spaces

without AZ® Aquatar® with AZ® Aquatar® μm - 1.2 -0.9 -0.6 -0.3 0 + 0.3 + 0.6 + 0.9 + 1.2





Softbake Hotplate 90°C, 60 sec AZ® Aquatar® anti-reflective coating, 2 300 rpm spin speed Exposure NIKON® 0.54 i-line stepper, 160 – 170 mJ/cm² Post Exposure Bake Hotplate 110°C, 60 sec

AZ® 300 MIF Developer (0.261 n), 5 sec spray, 55 sec puddle at 21°C

Typical Process Cycle		
Coat positive photoresist	AZ® 7800 or similar	
Softbake resist	90°C, 60 sec	
Coat AZ® Aquatar® to optimized target film thickness	i-Line: 650 Å (approx. 2 200 rpm spin speed)	
	g-Line: 770 Å (approx. 1 500 rpm spin speed)	
Exposure	g- or i-line stepper	
Post Exposure Bake	110°C, 60 sec	
Development	Dynamic dispense 5 sec, then puddle develop as usual,	
	rinse and spin dry	

Note

If the PEB temperature is higher than 110° C, we recommend that the AZ® Aquatar® top anti-reflective coating will be removed before baking with a 5 sec water rinse.

Characteristic				
Refractive Index	633 nm	1.408		
	365 nm	1.430		
	248 nm	1.468		
Swing Ratio	i-line exposure	i-line exposure		
	[AZ® 7800, 0.35 µm l/s]	9.7% with AZ® Aquatar®		
	(29.7% without AZ® Aquata	r [®])		
	KrF exposure			
	[AZ® DX 1100 P (si),			
	0.30 µm l/s]	15.3% with AZ® Aquatar®		
		(31.0% without AZ® Aquatar®)		

Equipment Compatibility

AZ® Aquatar® top anti-reflective coating is compatible with all commercially available wafer and photomask processing equipment. The following construction materials are preferred: stainless steel, glass, ceramic, PTFE, polypropylene and high-density polyethylene.

In-line filtration should be performed using a filter compatible to aqueous solutions. A photoresist solvent compatible filter should not be used with this material.

AZ® Aquatar® top anti-reflective coating is not compatible with photoresist solvents. For this reason scale coating operations should be carried out at an aqueous coating station so that discarded material goes directly to an aqueous drain. Often a develop station is used for initial coating trials.

Storage

Storage temperatures between 2°C and 35°C are recommended for long term storage. This solution is not improved by long term freezing.

Packaging

AZ® Aquatar® top anti-reflective coating is available in plastic gallon bottles, 4 litre or 10 litre NOWPAK containers as required.

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